

**High Efficiency CdTe/CdS Thin Film solar Cells by a Process Suitable for Large Scale Production.**

**N. Romeo, A. Bosio, A. Romeo, M. Bianucci, L. Bonci, C. Lenti**

*SSE-Solar Systems & Equipments*

Via S. Antonio M. Pucci, 84-55049- VIAREGGIO (Lu)-ITALY-

Tel. ++39 0584 45959 Fax. ++39 0584 45613 e-mail:Nicola.Romeo@fis.unipr.it

**ABSTRACT:** It has been demonstrated that CdTe/CdS thin film solar cells can exhibit an efficiency around 16.5%. However this efficiency has been obtained by adding some Cu at the back contact. Cu behaves as a shallow acceptor in CdTe and then it can increase the hole carrier density in CdTe. On the other hand, Cu is a fast diffusor in CdTe and at a long run it can segregates at the grain boundaries damaging the solar cell. In our process we did not use any copper but we developed a new ohmic contact which is very stable. This consists in a thin layer of 1000-2000 Å of Sb<sub>2</sub>Te<sub>3</sub> deposited by sputtering directly on top of the CdTe surface. With this new contact we were able to obtain an efficiency of 14% or more in CdTe/CdS solar cell whose area is 2 cm<sup>2</sup>. These cells kept under 20 suns for several days at 100°C not only do not degrade but they improve their efficiency. The process consist in a subsequent deposition of 5 different layers, 4 of which, namely TCO, CdS, Sb<sub>2</sub>Te<sub>3</sub> and Mo are deposited by sputtering and CdTe by CSS. The treatment with CdCl<sub>2</sub> is done by depositing 1500 Å of CdCl<sub>2</sub> on top of CdTe and with an annealing at 400°C in 500 mbar of Ar. After the treatment, Ar is pumped away keeping the substrate at 400°C. In this way, CdCl<sub>2</sub> is completely re-evaporated from the CdTe leaving a perfectly cleaned surface. Before the deposition of the contact, no etching is done on the CdTe surface. Due to the fact that no acids nor other kind of liquids such as Br-methanol are used in this process and considering that both sputtering and CSS are very scalable techniques, this process results to be very suitable for large scale production.

**Keywords:** CdTe; CdS; PV Materials; Thin Film.

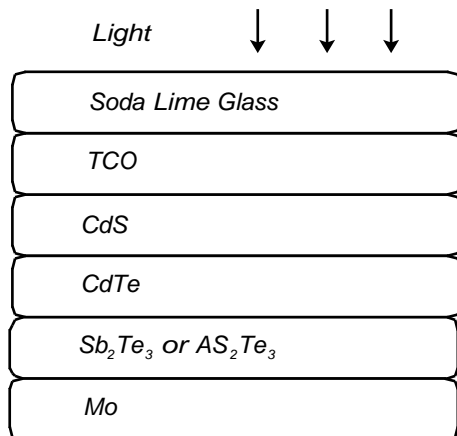
**1 INTRODUCTION**

CdTe/CdS thin film solar cells have a good possibility to be produced on large scale. A record 16.5% conversion efficiency has been recently reported from the NREL (National Renewable energy Laboratory) group (1). However, this high efficiency has been obtained by using a borosilicate glass as a substrate and by making a contact to CdTe with a paste containing copper. Borosilicate glass has to be avoided since it is too expensive while copper has the drawback to be a fast diffusor in CdTe and therefore it makes the cell to degrade in the long run.

We developed a process, which uses cheap soda-lime glass as a substrate with a stable contact that does not contain any copper. No liquids or acids are used. This process is capable to produce solar cells with efficiency of 14% or more.

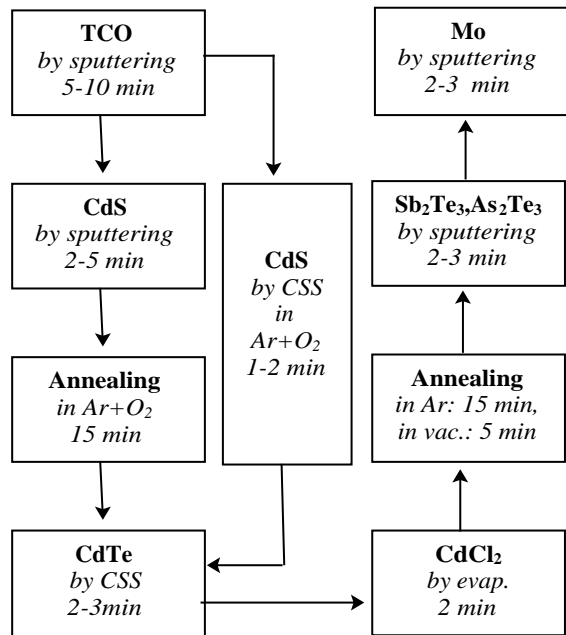
**2 BRIEF DESCRIPTION OF THE PROCESS**

The CdTe/CdS solar cells fabricated in our laboratory are made up of 5 layers (Fig. 1).



**Figure 1:** CdTe/CdS thin film solar cell structure

First, the soda-lime glass is covered by a 500 nm thick layer of a transparent conducting oxide (TCO) which in our case is fluorine doped In<sub>2</sub>O<sub>3</sub>. On top of the TCO a 100 nm thick layer of CdS is deposited by sputtering or close-spaced-sublimation. Before the deposition of CdTe, CdS is annealed for 15 min in an atmosphere containing O<sub>2</sub>. CdTe whose thickness is around 8 µm is deposited by closed-space-sublimation. Before making the top contact, CdTe is treated with CdCl<sub>2</sub> at 400°C in a chamber containing 500 mbar of Ar and then annealed in vacuum for a few minutes in order for the residuum CdCl<sub>2</sub> to be completely removed by evaporation. The top contact is made by depositing in sequence 150 nm of Sb<sub>2</sub>Te<sub>3</sub> or As<sub>2</sub>Te<sub>3</sub> and 150 nm of Mo by sputtering. No acids are used during the overall process. The sequence of the process is shown in fig. 2.



**Figure 2:** Block sequence of the CdTe/CdS thin film solar cell fabrication process

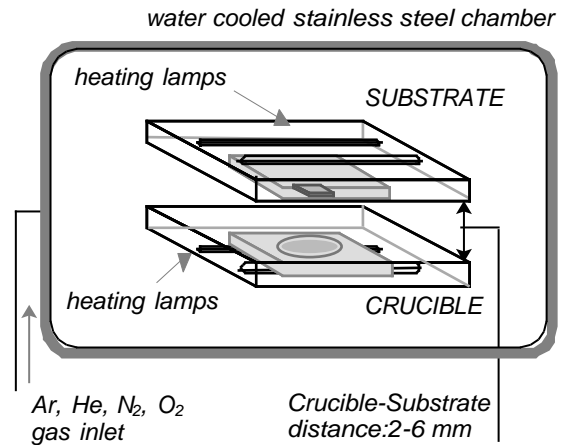
### 3 DETAILED DESCRIPTION OF THE PROCESS

#### 3.1 The transparent conducting oxide (TCO)

The most common TCO is  $\text{In}_2\text{O}_3$  containing 10% of Sn (ITO). This material has a very low resistivity on the order of  $3 \times 10^{-4} \Omega\text{cm}$  and high transparency ( $> 85\%$ ) in the visible spectrum. However, this material is made by sputtering and the ITO target after several runs forms some noodles which contain an In excess and a discharge between noodles can happen during sputtering which can damage the film. Another material, which is commonly used, is fluorine doped  $\text{SnO}_2$  which however exhibits a higher resistivity close to  $10^{-3} \Omega\text{cm}$  and as a consequence a  $1 \mu\text{m}$  thick layer is needed in order for the sheet resistance to be around  $10 \Omega/\text{square}$ . A high TCO thickness decreases the transparency and then the photocurrent of the solar cell. Finally a novel material, namely  $\text{Cd}_2\text{SnO}_4$ , has been developed by the NREL group (2). Also this material has some drawbacks since the target is made up of a mixture of  $\text{CdO}$  and  $\text{SnO}_2$  and, being  $\text{CdO}$  highly hygroscopic, the target is not much stable. A new TCO has been developed in our laboratory which is highly transparent and exhibits a resistivity of  $2.5 \times 10^{-4} \Omega\text{cm}$ . This TCO is simply  $\text{In}_2\text{O}_3$  which is doped with fluorine during the growth. The  $\text{In}_2\text{O}_3$  target differently from ITO does not form any noodle. A very low resistivity is obtained by introducing in the sputtering chamber a small amount of fluorine in form of  $\text{CHF}_3$  and a small amount of  $\text{H}_2$  in form of a mixture of  $\text{Ar}+\text{H}_2$  in which  $\text{H}_2$  is 20% in respect to Ar. A typical example is a 500 nm film of  $\text{In}_2\text{O}_3$  deposited with a deposition rate higher than  $10 \text{ \AA}/\text{sec}$  at a substrate temperature of  $500^\circ\text{C}$ , with an Ar flux of 200 sccm, a  $\text{CHF}_3$  flux of 5 sccm and a  $\text{Ar}+\text{H}_2$  flux of 20 sccm. This film exhibits a sheet resistance of  $5 \Omega/\text{square}$  and a transparency higher than 85% in the wavelength range of 400-800 nm. Another characteristic of this film is its good stability and the ability to stop Na diffusion from the soda-lime glass. This has been demonstrated by making  $\text{CdTe}/\text{CdS}$  solar cells on top of this type of TCO which have shown to be very stable even if heated up to  $180^\circ\text{C}$  when illuminated by "ten suns" for several hours.

#### 3.2 The CdS layer

$\text{CdS}$  is prepared by sputtering or Close-Spaced-Sublimation (CSS) This last technique allows the preparation of thin films at a substrate temperature much higher than that used in simple vacuum evaporation or sputtering. This because substrate and evaporation source are put very close one to each other at a distance of 2-6 mm and the deposition is done in presence of an inert gas such as Ar, He or  $\text{N}_2$  at a pressure of  $10^{-1} - 100$  mbar (fig. 3). The higher substrate temperature allows the growth of a better crystalline quality material. An important characteristic of the close-spaced-sublimation is a very high growth rate up to  $10 \mu\text{m}/\text{min}$ , which is suitable for large-scale production. However, this technique has a drawback: when small pieces containing dust are used as sublimation source, due to a different thermal contact, some micro-particles can be overheated and then spit on to the substrate together with the vapor. In order to avoid this drawback, complicated metallic masks are used in some cases. In our case we used a new sublimation source



**Figure 3:** Schematic diagram of the Close-Spaced-Sublimation (CSS) system

which consists in a compact block obtained by melting and solidifying the material in an oven able to sustain a temperature higher than the melting point of the material. The procedure to prepare the  $\text{CdS}$  compact block is as follows: pieces of  $\text{CdS}$  are put in a graphite container of the desired volume; the pieces are completely covered by boron oxide ( $\text{B}_2\text{O}_3$ ) which is a low melting point material ( $\approx 450^\circ\text{C}$ ) and exhibits a very low vapor pressure when melted. In this way  $\text{CdS}$  covered by  $\text{B}_2\text{O}_3$ , if it is put into an oven containing an inert gas at pressure higher than 50 atm, does not evaporate even at a temperature higher than its melting point. Since  $\text{CdS}$  melts at a temperature of  $1750^\circ\text{C}$ , the oven is heated up to a temperature of  $1800^\circ\text{C}$  or more and then cooled down to room temperature. In this way, a unique compact block of  $\text{CdS}$  is obtained which has demonstrated to be particularly suitable to be used as a sublimation source in a closed-space-sublimation system.  $\text{CdS}$  films prepared with this type of source resulted to be very smooth and completely free of dust. The  $\text{CdS}$  films used to prepare the  $\text{CdTe}/\text{CdS}$  solar cells are typically  $100 \text{ nm}$  thick. The substrate temperature is kept at  $300^\circ\text{C}$  when  $\text{CdS}$  is prepared by sputtering and at  $500^\circ\text{C}$  when it is prepared by close-spaced-sublimation. The sputtered  $\text{CdS}$  layer needs an annealing at  $500^\circ\text{C}$  in an atmosphere containing  $\text{O}_2$  in order for the  $\text{CdS}/\text{CdTe}$  solar cell to exhibit a high efficiency. In the case  $\text{CdS}$  is prepared by closed-space-sublimation,  $\text{O}_2$  is introduced in the sublimation chamber during the deposition. The role of  $\text{O}_2$  is not known but presumably it could be useful to passivate the  $\text{CdS}$  grain boundaries.

#### 3.3 The CdTe layer

$\text{CdTe}$  films are deposited on top of  $\text{CdS}$  by close-spaced-sublimation at a substrate temperature of  $500^\circ\text{C}$ . The  $\text{CdTe}$  source is a compact block obtained by melting and solidifying pieces of  $\text{CdTe}$  in an oven under high pressure as described previously. Since  $\text{CdTe}$  melts at  $1120^\circ\text{C}$ , the oven needs to be heated up to  $1200^\circ\text{C}$  in order to have a complete melting of the  $\text{CdTe}$  pieces. Deposition rates during the  $\text{CdTe}$  growth are typically  $4 \mu\text{m}/\text{min}$ . In this way  $8 \mu\text{m}$  of  $\text{CdTe}$  are deposited in 2 min.

#### 3.4 Treatment of CdTe with $\text{CdCl}_2$

An important step in the preparation of high

efficiency CdTe/CdS solar cells is the treatment of CdTe with CdCl<sub>2</sub>. Most research groups use to make this step by depositing on top of CdTe a layer of CdCl<sub>2</sub> by simple evaporation or by dipping CdTe in a methanol solution containing CdCl<sub>2</sub> and then anneal the material in air at 400°C for 15-20 min. It is generally believed that the CdCl<sub>2</sub> treatment improves the crystalline quality of CdTe by increasing the size of small grains and by removing several defects in the material.

After CdCl<sub>2</sub> treatment, CdTe is commonly etched in a solution of Br-methanol or in a mixture of nitric and phosphoric acid. This etching is necessary in the case the CdCl<sub>2</sub> treatment is done in air since CdO or CdTeO<sub>3</sub> are generally formed on the CdTe surface. CdO and/or CdTeO<sub>3</sub> have to be removed in order to make a good back contact onto CdTe. Besides it is believed that the etching, producing a Te-rich surface, facilitates the formation of an ohmic contact when a metal is deposited on top of CdTe (3).

We developed a new method to make the CdCl<sub>2</sub> treatment, which avoids the etching and contemporarily allows to make a good contact. The procedure is as follows:

100-150 nm of CdCl<sub>2</sub> are deposited by evaporation on top of CdTe with the substrate kept at room temperature. An annealing of 15-20 min is done at 400°C in a vacuum chamber in which 500 mbar of Ar are introduced. After the annealing the chamber is evacuated keeping the substrate at 400°C for 5 min. since CdCl<sub>2</sub> has a high vapor pressure at 400°C, any CdCl<sub>2</sub> residuum re-evaporates from the CdTe surface. CdO or CdTeO<sub>3</sub> are not formed since the annealing is done in an inert atmosphere which does not contain O<sub>2</sub>. We found that a Te-rich surface is not needed to make a not-rectifying contact if the contact is made by depositing on top of CdTe a thin layer of a highly conducting p-type semiconductors such as Sb<sub>2</sub>Te<sub>3</sub> or As<sub>2</sub>Te<sub>3</sub>.

### 3.5 Back contact

A good not rectifying contact is obtained on a clean CdTe surface if 150 nm of Sb<sub>2</sub>Te<sub>3</sub> or As<sub>2</sub>Te<sub>3</sub> are deposited by sputtering at a substrate temperature respectively of 300°C and 250°C. Sb<sub>2</sub>Te<sub>3</sub> grows naturally p-type with a resistivity of 10<sup>-4</sup> Ωcm while As<sub>2</sub>Te<sub>3</sub> grows p-type with a resistivity of 10<sup>-3</sup> Ωcm. The contact procedure is completed by covering the low resistivity p-type semiconductor with 150 nm of Mo.

## 4 CdTe/CdS SOLAR CELLS CHARACTERISTICS

By following the procedure described before several solar cells have been prepared by using as a substrate a 1 inch square low-cost soda-lime glass.

A typical area of these cells is 1-2 cm<sup>2</sup>. The finished cells are generally put under 10-20 suns for several hours at a temperature of 180°C in the open-circuit-voltage conditions. No degradation has been notified but rather a 20% or more increase in the efficiency has been found.

The efficiency of these cells is in the range of 12% - 14% with open-circuit-voltages (V<sub>oc</sub>) larger than 800 mV, short-circuit-currents (J<sub>sc</sub>) of 22-25 mA/cm<sup>2</sup> and fill-factors (ff) ranging from 0.6 to 0.66. As an example a cell exhibiting a 14% efficiency has been prepared in the following way: a soda-lime glass has been covered by 500 nm of In<sub>2</sub>O<sub>3</sub>:F (fluorine-doped) deposited at

500°C substrate temperature as it has been described in section 3.1; 100 nm of CdS have been deposited by sputtering at 300°C substrate temperature and annealed for 15 min at 500°C in 500 mbar of Ar containing 20% of O<sub>2</sub>; 8µm of CdTe have been deposited on top of CdS by CSS at a substrate temperature of 500°C as described in section 3.3; a treatment with 150 nm of CdCl<sub>2</sub> has been done in an Ar atmosphere as described in section 3.4; without any etching, a contact, depositing by sputtering in sequence 150 nm of Sb<sub>2</sub>Te<sub>3</sub> and 150 nm of Mo has been made.

After one hour under 10 suns at a temperature of 180°C in open-circuit conditions the solar cell exhibited the following parameters:

$$\begin{array}{ll} V_{oc} \approx 852 \text{ mv} & J_{sc} \approx 25 \text{ mA/cm}^2 \\ ff \approx 0.66 & \text{efficiency} \approx 14\% \end{array}$$

The techniques used in this process such as sputtering and close-spaced-sublimation are both fast, reproducible and easily scalable. At least three innovation have been introduced with this process:

- the TCO, which is fluorine-doped In<sub>2</sub>O<sub>3</sub>;
- a compact CdTe and CdS source for the close-spaced-sublimation;
- a CdCl<sub>2</sub> treatment and back contact which does not make use of acids or liquids, rendering the process even faster and avoiding the danger and the law restrictions due to the use of acid tanks.

We can conclude that the process described above can be used for the fabrication in-line of CdTe/CdS photovoltaic modules at a high production rate.

## 5 REFERENCES

- [1] X. Wu, J.C. Keane, R.G. Dhere, C. DeHart, D.S. Albin, A. Duda, T.A. Gessert, S. Asher, D.H. Levi, and P. Sheldon  
Proc. 17<sup>th</sup> European Photovoltaic Solar Energy Conference, Munich, Germany, 22-26 October 2001, **II**, 995-1000
- [2] X. Wu, W.P. Mulligan, T.J. Coutts, Thin Solid Films, **286** (1996) 274-276
- [3] Dieter Bonnet  
Thin Solid Films **361-362** (2000) 547-552